

## **FGW40N120WE**

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**Discrete IGBT** 

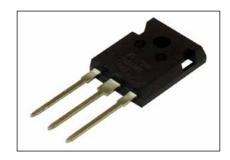
# Discrete IGBT (High-Speed W series) 1200V / 40A

#### Features

Low power loss Low switching surge and noise High reliability, high ruggedness (RBSOA, SCSOA etc.)

#### Applications

Uninterruptible power supply PV Power coditionner Inverter welding machine

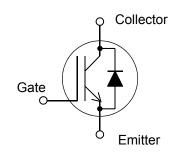


#### **■** Equivalent circuit

#### ■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at T<sub>i</sub>=25°C (unless otherwise specified)

Items	Symbol	Characteristics	Unit	Remarks
Collector-Emitter voltage	Vces	1200	V	
Gate-Emitter voltage	V <sub>GES</sub>	±20	V	
DC Collector Current	Ic@25	65	Α	Tc=25°C, Tj=150°C
	Ic@100	40	Α	Tc=100°C, Tj=150°C
Pulsed Collector Current	I <sub>CP</sub>	160	Α	Note *1
Turn-Off Safe Operating Area	-	160	Α	Vce≤1200V, Tj≤175°C
Diode Forward Current	I <sub>F@25</sub>	60	Α	
	IF@100	40	Α	
Diode Pulsed Current	I <sub>FP</sub>	160	Α	Note *1
Short Circuit Withstand Time	tsc	5	μs	Vcc≤600V, VgE=15V Tj≤150°C
IGBT Max. Power Dissipation	P <sub>D_IGBT</sub>	430	W	Tc=25°C
FWD Max. Power Dissipation	P <sub>D_FWD</sub>	190	٧V	Tc=25°C
<b>Operating Junction Temperature</b>	T <sub>j</sub>	-40~+175	°C	
Storage Temperature	T <sub>stg</sub>	-55~+175	°C	



Note \*1 : Pulse width limited by Tjmax.

● Electrical characteristics at T<sub>i</sub>= 25°C (unless otherwise specified) Static Characteristics

Description	Symbol	Conditions		min.	typ.	max.	Unit	
Zero Gate Voltage Collector Current	Ices	Vce = 1200V. Vge = 0V	T <sub>j</sub> =25°C	-	-	250	μΑ	
•	ICES	, , , , , , , , , , , , , , , , , , , ,	T <sub>j</sub> =175°C	-	-	2	mA	
Gate-Emitter Leakage Current	Iges	$V_{CE} = 0V$ , $V_{GE} = \pm 20V$		-	-	200	nA	
Gate-Emitter Threshold Voltage	V <sub>GE (th)</sub>	V <sub>CE</sub> = 20V, I <sub>C</sub> = 40mA		5.0	6.0	7.0	V	
Callantan Emittan Catamatian Valtana	V <sub>CE</sub> (sat)	V <sub>GE</sub> = 15V, I <sub>C</sub> = 40A	T <sub>j</sub> =25°C	-	2.0	2.6	V	
Collector-Emitter Saturation Voltage		VGE - 15V, IC - 4UA	T <sub>j</sub> =175°C	-	2.6	-		
Input Capacitance	Cies	Vce=25V	•	-	2500	-		
Output Capacitance	Coes	V <sub>GE</sub> =0V		-	110	-	pF	
Reverse Transfer Capacitance	Cres	f=1MHz		-	34			
		Vcc = 400V						
Gate Charge	Q <sub>G</sub>	Ic = 40A		-	120	-	nC	
, and the second		V <sub>GE</sub> = 15V						
Turn-On Delay Time	t <sub>d(on)</sub>	T <sub>i</sub> = 25°C		-	36	-		
Rise Time	t	Vcc = 600V		-	66	-		
Turn-Off Delay Time	t <sub>d(off)</sub>	Ic = 40A		-	178	-	ns	
Fall Time	tr	V <sub>GE</sub> = 15V		-	40	-		
Turn-On Energy	Eon	R <sub>G</sub> = 10Ω		-	3.0	-		
		L = 500µH						
Turn-Off Energy	Eoff	Energy loss include "tail" and FWD		-	1.6	-	mJ	
<b>.</b> ,		(FDRW30S120J) reverse r	ecovery.					
Turn-On Delay Time	t <sub>d(on)</sub>	T <sub>j</sub> = 175°C V <sub>cc</sub> = 600V I <sub>c</sub> = 40A V <sub>GE</sub> = 15V		-	36	-	ns	
Rise Time	t			-	58	-		
Turn-Off Delay Time	t <sub>d(off)</sub>			-	220	-		
Fall Time	tr			-	56	-		
Turn-On Energy	Eon	R <sub>G</sub> = 10Ω		-	4.8	-		
<u> </u>		L = 500µH					1	
Turn-Off Energy	Eoff	Energy loss include "tail" a	Energy loss include "tail" and FWD			-	mJ	
••		(FDRW30S120J) reverse r	ecovery.					
Forward Voltage Drop	VF	<u> </u>	T <sub>j</sub> =25°C	-	2.40	3.36	V	
	VF	I <sub>F</sub> =40A	T <sub>j</sub> =175°C	-	2.10	-	V	
Diode Reverse Recovery Time	trr	Vcc=600V		-	0.45	-	ns	
•		I <sub>F</sub> = 40A						
Diode Reverse Recovery Charge	Qrr	-di/dt=600A/µs		-	2.20	-	μC	
, ,		T <sub>j</sub> =25°C						
Diode Reverse Recovery Time	trr	Vcc=600V		-	0.85	-	μs	
į		I==40A						
Diode Reverse Recovery Charge	Qrr	-di⊧/dt=600A/µs		_	7.10	-	μC	
, , , , , , , , , , , , , , , , , , ,		T <sub>i</sub> =175°C					r -	

FGW40N120WE Discrete IGBT

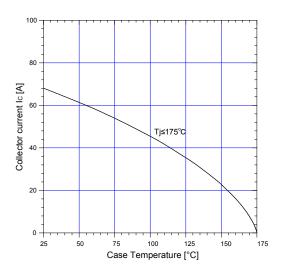
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#### ● Thermal Resistance

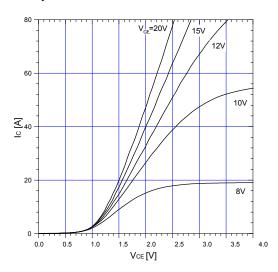
Description	Symbol	min.	typ.	max.	Unit
Thermal Resistance, Junction-Ambient	R <sub>th(j-a)</sub>	-	-	50	°C/W
Thermal Resistance, IGBT Junction to Case	R <sub>th(j-c)_IGBT</sub>	-	-	0.347	°C/W
Thermal Resistance, FWD Junction to Case	Rth(j-c) FWD	-	-	0.781	°C/W

#### ■ Characteristics (Representative)

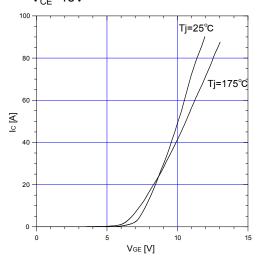
Graph.1 DC Collector Current vs Tc V<sub>GE</sub>≥+15V,Tj≤175°C



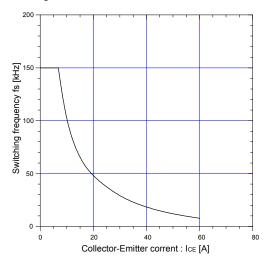
Graph.3
Typical Output Characteristics (VcE-Ic)
Ti=25°C



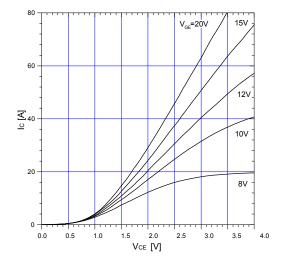
Graph.5 Typical Transfer Characteristics V<sub>CE</sub>=15V



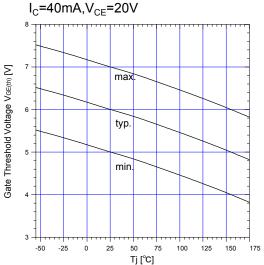
Graph.2 Collector Current vs. switching frequency  $V_{GE}$ =+15V,Tc≤175°C,Vcc=600V,D=0.5,  $R_{G}$ =10 $\Omega$ ,Tc=100°C



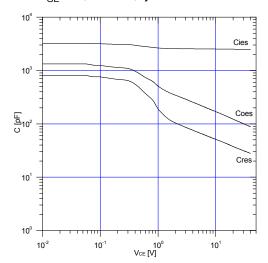
Graph.4
Typical Output Characteristics (VcE-Ic)
Tj=175°C



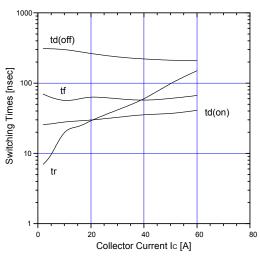
Graph.6
Gate Threshold Voltage vs. Tj



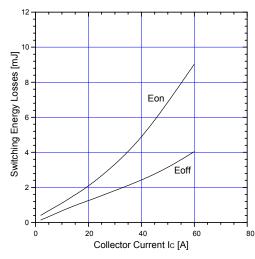
Graph.7 Typical Capacitance V<sub>GE</sub>=0V,f=1MHz,Tj=25°C



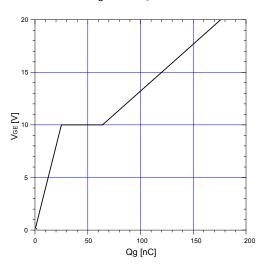
Graph.9 Typical switching time vs. Ic Tj=175°C,Vcc=600V,L=500 $\mu$ H V<sub>GE</sub>=15V,R<sub>G</sub>=10 $\Omega$ 



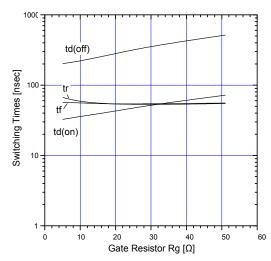
Graph.11 Typical switching losses vs. Ic Tj=175°C,Vcc=600V,L=500 $\mu$ H V<sub>GE</sub>=15V,R<sub>G</sub>=10 $\Omega$ 



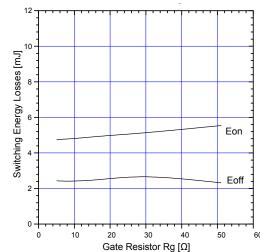
Graph.8
Typical Gate Charge
Vcc=600V,I<sub>C</sub>=40A,Tj=25°C



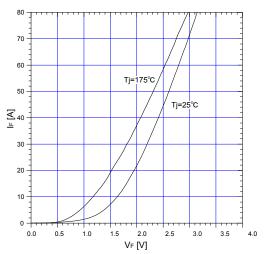
Graph.10 Typical switching time vs. Rg Tj=175°C,Vcc=600V,I $_{\rm C}$ =40A,L=500 $\mu$ H V $_{\rm GE}$ =15V



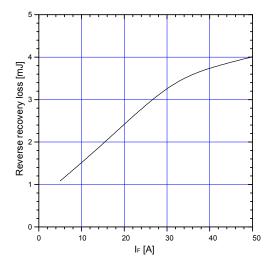
Graph.12 Typical switching losses vs. Rg Tj=175°C,Vcc=600V,I<sub>C</sub>=40A,L=500 $\mu$ H V<sub>GE</sub>=15V



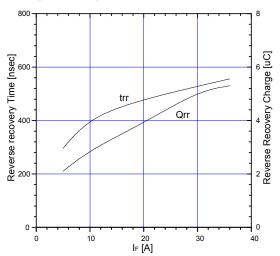
Graph.13 FWD Forward voltage drop (VF-IF)



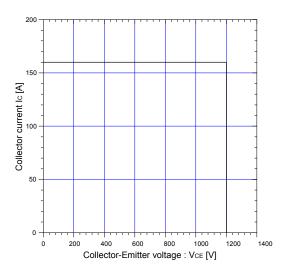
Graph.15 Typical reverse recovery loss vs. IF Tj=175°C,Vcc=600V,L=500 $\mu$ H V<sub>GE</sub>=15V,R<sub>G</sub>=10 $\Omega$ 



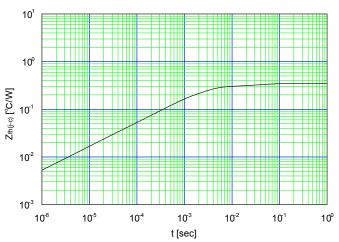
Graph.14 Typical reverse recovery characteristics vs. IF Tj=175°C,Vcc=600V,L=500 $\mu$ H V<sub>GE</sub>=15V,R<sub>G</sub>=10 $\Omega$ 



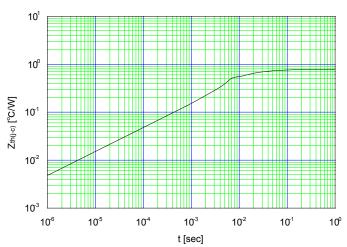
Graph.16 Reverse biased Safe Operating Area Tj≤175°C, $V_{GE}$ =+15V/0V, $R_{G}$ =10 $\Omega$ 



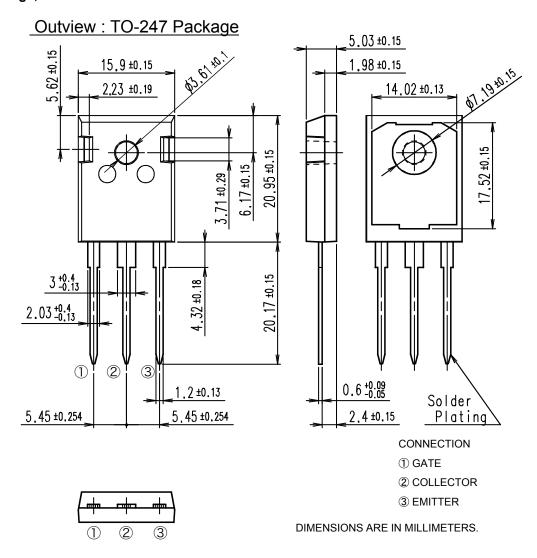
Graph.17
Transient thermal resistance of IGBT



Graph.18
Transient thermal resistance of FWD



#### Outline Drawings, mm



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